IMPORTANT NOTICE

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As of December 7th, 2015 BL RF Power of NXP Semiconductors will operate as an independent company under the new trade name Ampleon, which will be used in future data sheets together with new contact details.

In data sheets, where the previous Philips references is mentioned, please use the new links as shown below.

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sales.addresses@www.semiconductors.philips.com use http://www.ampleon.com/sales

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If you have any questions related to the data sheet, please contact our nearest sales office (details via http://www.ampleon.com/sales).

Thank you for your cooperation and understanding,

Ampleon

UHF power MOS transistor

BLF544

FEATURES

- · High power gain
- · Easy power control
- · Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

APPLICATIONS

Communication transmitters in the UHF frequency range.

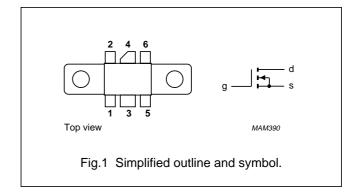
DESCRIPTION

N-channel enhancement mode vertical D-MOS power transistor encapsulated in a 6-lead, SOT171A flange package with a ceramic cap. All leads are isolated from the flange.

A marking code showing gate-source voltage (V_{GS}) information is provided for matched pair applications.

PINNING - SOT171A

PIN	DESCRIPTION
1	source
2	source
3	gate
4	drain
5	source
6	source



QUICK REFERENCE DATA

RF performance at T_h = 25 °C in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	20	>11	>50
CW, class-B	960	28	20	typ. 7	typ. 50

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

UHF power MOS transistor

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LIMITING VALUES

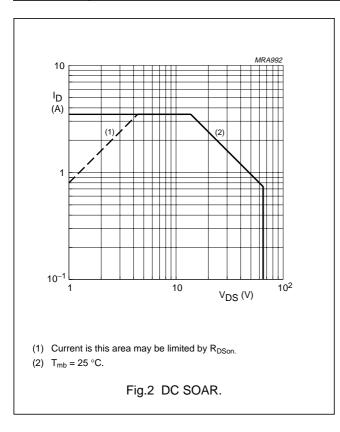
In accordance with the Absolute Maximum Rating System (IEC 60134).

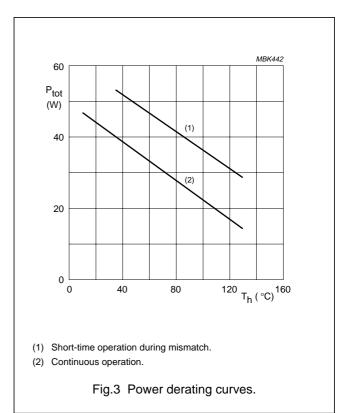
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		_	65	V
V_{GS}	gate-source voltage		_	±20	V
I _D	drain current (DC)		_	3.5	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C	_	48	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	3.7	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	0.4	K/W

3





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UHF power MOS transistor

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CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

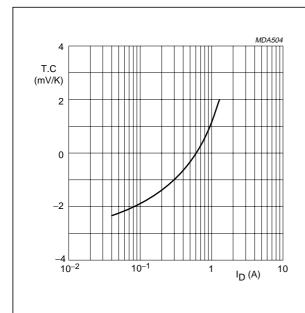
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 10 mA	65	_	_	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	_	_	1	mA
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	_	_	1	μΑ
V _{GSth}	gate-source threshold voltage	I _D = 40 mA; V _{DS} = 10 V	1	_	4	٧
ΔV_{GSth}	gate-source voltage difference of matched pairs	$I_D = 40 \text{ mA}; V_{DS} = 10 \text{ V}$	_	-	100	mV
g _{fs}	forward transconductance	I _D = 1.2 A; V _{DS} = 10 V	600	900	_	mS
R _{DSon}	drain-source on-state resistance	I _D = 1.2 A; V _{GS} = 10 V	_	0.85	1.25	Ω
I _{DSX}	on-state drain current	V _{GS} = 15 V; V _{DS} = 10 V	_	4.8	_	Α
C _{is}	input capacitance	$V_{GS} = 0$; $V_{DS} = 28 \text{ V}$; $f = 1 \text{ MHz}$	_	32	_	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	24	_	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	6.4	_	pF

V_{GS} group indicator

GROUP		IITS V)	GROUP	LIMITS (V)		
	MIN.	MAX.		MIN.	MAX.	
А	2.0	2.1	0	3.3	3.4	
В	2.1	2.2	Р	3.4	3.5	
С	2.2	2.3	Q	3.5	3.6	
D	2.3	2.4	R	3.6	3.7	
E	2.4	2.5	S	3.7	3.8	
F	2.5	2.6	Т	3.8	3.9	
G	2.6	2.7	U	3.9	4.0	
Н	2.7	2.8	V	4.0	4.1	
J	2.8	2.9	W	4.1	4.2	
K	2.9	3.0	Х	4.2	4.3	
L	3.0	3.1	Y	4.3	4.4	
М	3.1	3.2	Z	4.4	4.5	
N	3.2	3.3				

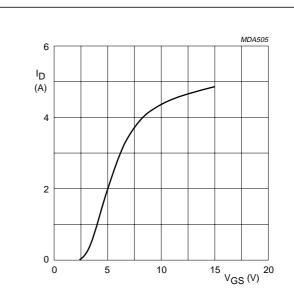
UHF power MOS transistor

BLF544



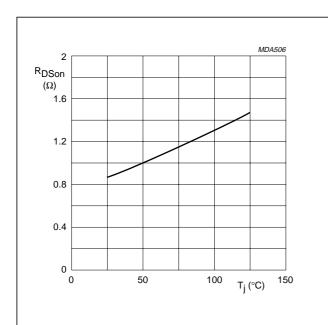
 $V_{DS} = 10 \text{ V}.$

Fig.4 Temperature coefficient of gate-source voltage as a function of drain current; typical values.



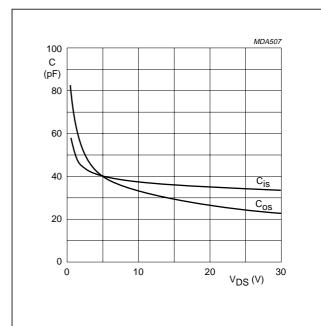
 $V_{DS} = 10 \text{ V}; T_j = 25 ^{\circ}\text{C}.$

Fig.5 Drain current as a function of gate-source voltage; typical values.



 $I_D = 1.2 \text{ A}; V_{GS} = 10 \text{ V}.$

Fig.6 Drain-source on-state resistance as a function of junction temperature; typical values.

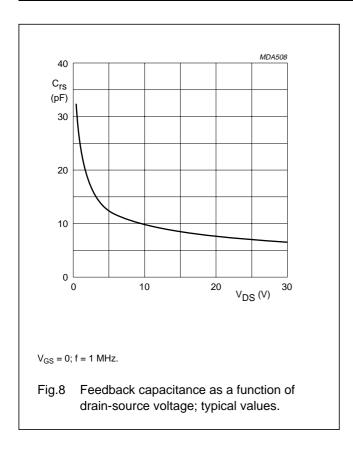


 $V_{GS} = 0$; f = 1 MHz.

Fig.7 Input and output capacitance as functions of drain-source voltage; typical values.

UHF power MOS transistor

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APPLICATION INFORMATION

 T_h = 25 °C; $R_{th\ mb-h}$ = 0.4 K/W unless otherwise specified. RF performance in a common source class-B circuit.

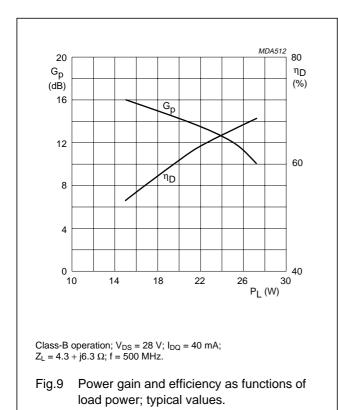
MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	40	20	>11	>50
					typ. 14	typ. 60
CW, class-B	960	28	40	20	typ. 7	typ. 50
CW, class-B	960	24	40	15	typ. 7	typ. 50

Ruggedness in class-B operation

The BLF544 is capable of withstanding a full load mismatch corresponding to VSWR = 50: 1 through all phases under the following conditions: $V_{DS} = 28 \text{ V}$; f = 500 MHz at rated output power.

UHF power MOS transistor

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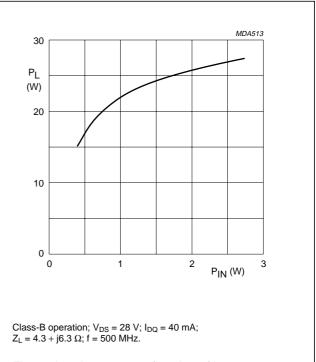
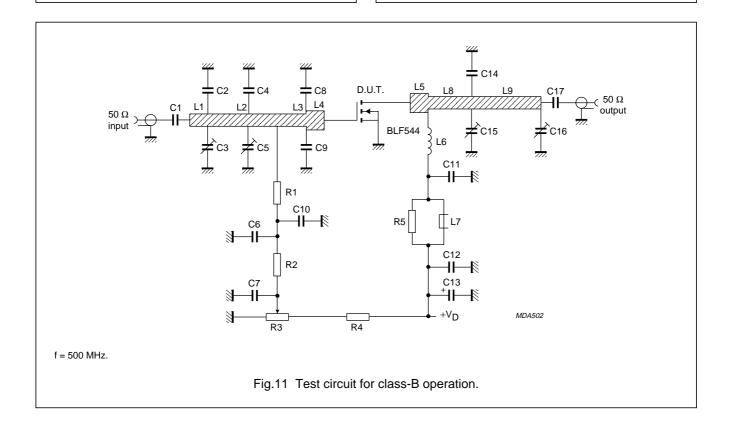


Fig.10 Load power as a function of input power; typical values.



UHF power MOS transistor

BLF544

List of components (see Figs 11 and 12).

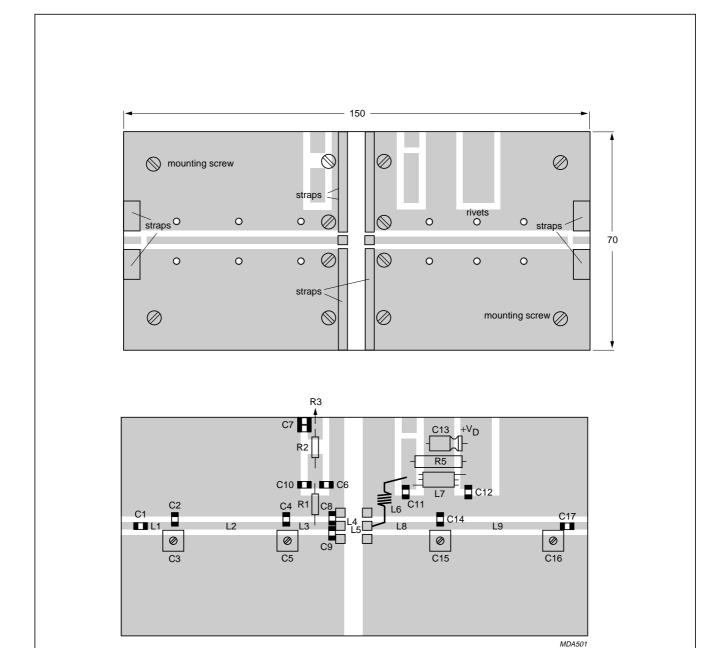
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C6, C11, C17	multilayer ceramic chip capacitor; note 1	390 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C3, C5	film dielectric trimmer	2 to 9 pF		2222 809 09002
C4	multilayer ceramic chip capacitor; note 2	27 pF; 50 V		
C7	multilayer ceramic chip capacitor	2 × 100 nF in parallel; 50 V		2222 852 47104
C8, C9	multilayer ceramic chip capacitor; note 2	39 pF		
C10, C12	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C13	electrolytic capacitor	4.7 μF; 63 V		2222 030 38478
C14	multilayer ceramic chip capacitor; note 1	20 pF; 500 V		
C15, C16	film dielectric trimmer	2 to 18 pF		2222 809 09003
L1	stripline note 3	50 Ω	9.5 × 2.5 mm	
L2	stripline note 3	50 Ω	34.5 × 2.5 mm	
L3	stripline note 3	50 Ω	17.5 × 2.5 mm	
L4, L5	stripline note 3	42 Ω	3 × 3 mm	
L6	4 turns enamelled 0.8 mm copper wire	31 nH	length 7.5 mm int. dia. 3 mm leads 2 × 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L8	stripline note 3	50 Ω	22 × 2.5 mm	
L9	stripline note 3	50 Ω	39.5 × 2.5 mm	
R1, R2	0.4 W metal film resistor	1 kΩ		2322 151 11002
R3	10 turns cermet potentiometer	50 kΩ		
R4	0.4 W metal film resistor	140 kΩ		2322 151 11404
R5	1 W metal film resistor	10 Ω		2322 153 51009

Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 3. The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE (ϵ_r = 2.2); thickness 1/32 inch.

UHF power MOS transistor

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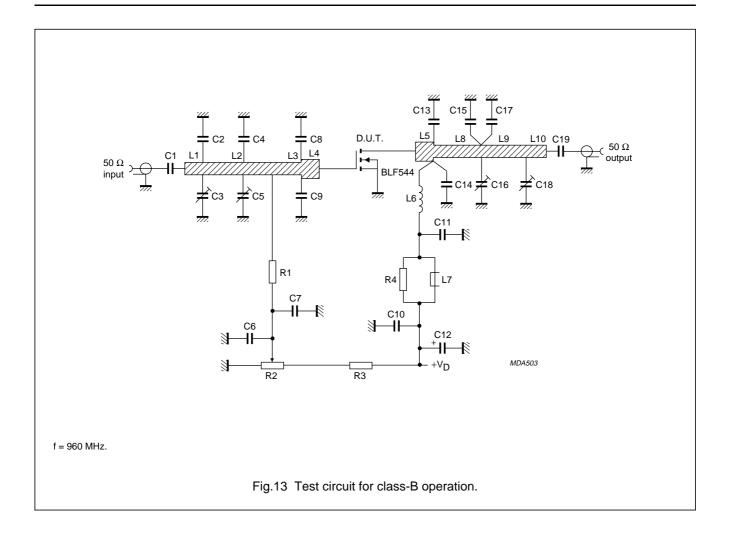
Dimensions in mm.

The circuit and components are situated on one side of the printed circuit board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 500 MHz class-B test circuit.

UHF power MOS transistor

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UHF power MOS transistor

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List of components (see Figs 12 and 13)

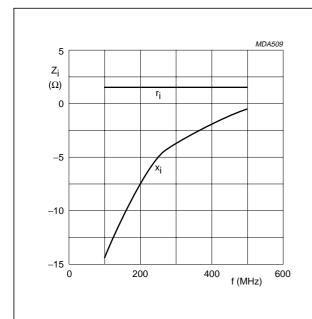
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1	multilayer ceramic chip capacitor; note 1	68 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	1.6 pF; 50 V		
C3, C5, C16, C18	film dielectric trimmer	1.4 to 5.5 pF		2222 809 09001
C4	multilayer ceramic chip capacitor; note 2	1 pF; 50 V		
C6	multilayer ceramic chip capacitor	10 nF; 50 V		2222 852 47103
C7, C11	multilayer ceramic chip capacitor; note 1	56 μF; 500 V		
C8, C9, C15, C17	multilayer ceramic chip capacitor; note 2	6.8 μF; 50 V		
C10	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C12	electrolytic capacitor	4.7 μF; 63 V		2222 030 38478
C13	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C14	multilayer ceramic chip capacitor; note 2	18 pF; 50 V		
C19	multilayer ceramic chip capacitor; note 1	62 pF; 500 V		
L1, L8	stripline; note 3	50 Ω	6 × 2.5 mm	
L2	stripline; note 3	50 Ω	38 × 2.5 mm	
L3	stripline; note 3	50 Ω	17.5 × 2.5 mm	
L4, L5	stripline; note 3	42 Ω	3 × 3 mm	
L6	2 turns enamelled 1 mm copper wire	16 nH	length 3.4 mm int. dia. 3 mm leads 2 × 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L9	stripline; note 3	50 Ω	21 × 2.5 mm	
L10	stripline; note 3	50 Ω	34.5 × 2.5 mm	
R1	0.4 W metal film resistor	15 kΩ		2322 151 11473
R2	10 turns potentiometer	50 kΩ		
R3	0.4 W metal film resistor	140 kΩ		2322 151 11404
R4	0.4 W metal film resistor	10 Ω		2322 153 51009

Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 3. The striplines are on a double copper-clad printed-circuit board with glass microfibre reinforced PTFE (ϵ_r = 2.2); thickness 1/32 inch.

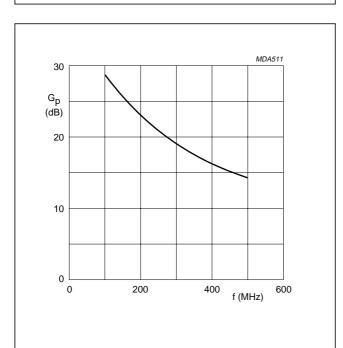
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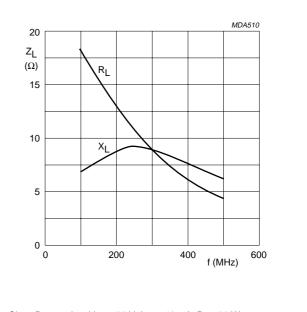
Class-B operation; V_{DS} = 28 V; I_{DQ} = 40 mA; P_{L} = 20 W.

Fig.14 Input impedance as a function of frequency (series components); typical values.



Class-B operation; V_{DS} = 28 V; I_{DQ} = 40 mA; P_L = 20 W.

Fig.16 Power gain as a function of frequency; typical values.



Class-B operation; V_{DS} = 28 V; I_{DQ} = 40 mA; P_L = 20 W.

Fig.15 Load impedance as a function of frequency (series components); typical values.

Optimum input and load impedances

Optimum input impedance: 1.2 + j4.8 Ω . Optimum load impedance: 2.6 - j3.1 Ω . Conditions: class-B operation; V_{DS} = 24 V;

 I_{DQ} = 40 mA; f = 960 MHz; P_L = 15 W; typical values.

UHF power MOS transistor

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BLF544 scattering parameters

 $V_{DS} = 28 \text{ V}; I_D = 40 \text{ mA}; \text{ note 1}$

f (MHz)	f (MHz)		s ₂₁		s ₁	2	s	s ₂₂	
1 (WIT12)	s ₁₁	∠Φ	s ₂₁	∠Φ	s ₁₂	∠Φ	s ₂₂	∠Φ	
5	0.99	-14.0	13.60	171.0	0.02	81.0	0.89	-12.8	
10	0.98	-27.6	13.20	162.0	0.04	72.4	0.87	-25.3	
20	0.93	-52.0	11.90	146.0	0.07	57.1	0.82	-48.0	
30	0.88	-72.0	10.30	134.0	0.09	44.8	0.77	-66.6	
40	0.84	-87.7	8.93	124.0	0.10	35.2	0.72	-81.3	
50	0.81	-100.0	7.75	116.0	0.11	27.7	0.68	-93.0	
60	0.79	-110.0	6.78	110.0	0.12	21.6	0.66	-102.0	
70	0.77	-118.0	6.00	104.0	0.12	16.7	0.64	-109.0	
80	0.76	-124.0	5.36	99.8	0.12	12.5	0.63	-115.0	
90	0.75	-129.0	4.82	95.9	0.12	8.9	0.62	-120.0	
100	0.75	-133.0	4.37	92.3	0.13	5.7	0.61	-124.0	
125	0.74	-141.0	3.53	84.7	0.13	-1.1	0.61	-131.0	
150	0.74	-147.0	2.94	78.3	0.13	-6.6	0.61	-137.0	
175	0.74	-151.0	2.50	72.6	0.12	-11.5	0.62	-140.0	
200	0.75	-154.0	2.16	67.5	0.12	-15.8	0.64	-143.0	
250	0.77	-159.0	1.67	58.4	0.12	-23.3	0.67	-148.0	
300	0.78	-163.0	1.33	50.4	0.11	-29.7	0.70	-151.0	
350	0.80	-167.0	1.09	43.1	0.10	-35.3	0.73	-154.0	
400	0.82	-169.0	0.91	36.6	0.10	-40.3	0.75	-157.0	
450	0.84	-172.0	0.77	30.6	0.09	-44.7	0.78	-160.0	
500	0.85	-175.0	0.66	25.1	0.08	-48.6	0.80	-162.0	
600	0.89	-179.0	0.50	15.6	0.07	-55.2	0.84	-167.0	
700	0.90	177.0	0.39	7.5	0.06	-60.4	0.88	-170.0	
800	0.92	173.0	0.32	0.6	0.05	-64.3	0.90	-174.0	
900	0.93	169.0	0.26	-5.4	0.04	-67.3	0.92	-177.0	
1000	0.94	166.0	0.22	-10.8	0.04	-69.2	0.93	-179.0	

Note

^{1.} For more extensive s-parameters see internet: http://www.semiconductors.philips.com/markets/communications/wirelesscommunication/broadcast.

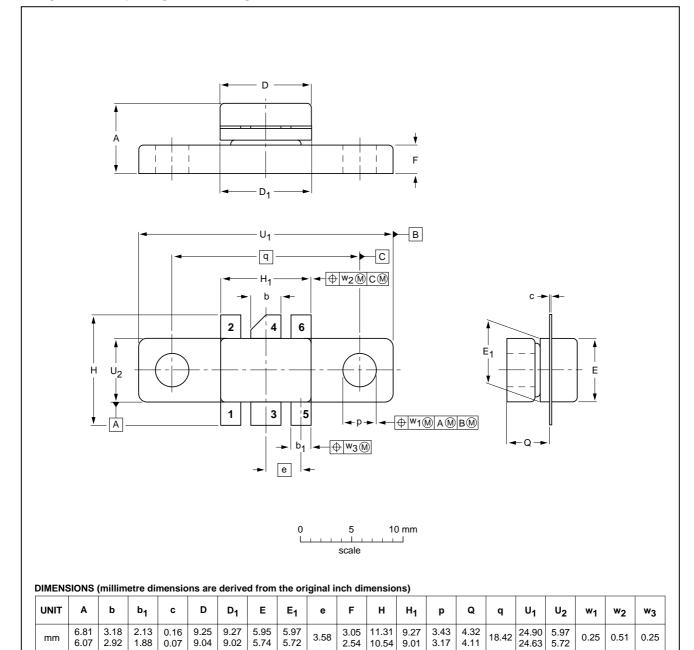
UHF power MOS transistor

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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 6 leads

SOT171A



OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE
VERSION	IEC	IEC JEDEC EIAJ			PROJECTION	ISSUE DATE
SOT171A						99-03-29

 0.120
 0.445
 0.365
 0.135
 0.170

 0.100
 0.415
 0.355
 0.125
 0.162

0.980 0.235 0.970 0.225

0.010 0.020 0.010

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 0.268
 0.125
 0.084
 0.006
 0.364
 0.365
 0.234
 0.235

 0.239
 0.115
 0.074
 0.003
 0.356
 0.355
 0.226
 0.225

UHF power MOS transistor

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LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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Printed in The Netherlands

613524/03/pp16

Date of release: 2003 Sep 18

Document order number: 9397 750 11589

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